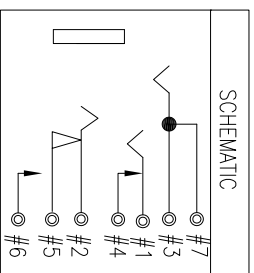
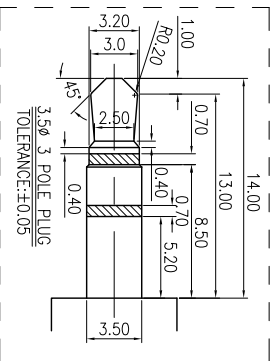


RECOMMENDED P.C.B. LAYOUT T=1.20
TOP VIEW (TOLERANCE: ±0.05)



- SPECIFICATIONS:
- ELECTRICAL CHARACTERISTICS:
 - RATING: 36V AC, 1A DC.
 - CONTACT RESISTANCE: 50mΩ MAX.
 - DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - INSULATION RESISTANCE: 100MΩ MIN. MEASURED BY 500 VDC.
 - MECHANICAL CHARACTERISTICS:
 - INSERTION FORCE : 0.4~3.0 KGF
 - WITHDRAWAL FORCE : 0.3~2.0 KGF
 - LIFE TEST: 5,000 CYCLES MIN.
 - OTHER GENERAL SPEC. TO REFER "2SJ2285 SERIES SPEC".
 - TO CONFORM TO THE SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
 - HALOGEN PRODUCT IDENTIFICATION MARK ON JACK: ◎
 - HALOGEN PRODUCT IDENTIFICATION LABEL ON PACKAGING.
 - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
 - PACKAGING: TAPE&REEL.



REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCED RELEASED	JUNHUA	2009.05.13
B	ECN MOD110149-17Modify Pading specification	BILLY	2011.06.23
C	ECN NO.C140074 MODIFY LAYOUT	ZLS	2014.7.28

NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
A	BODY	1	HIGH TEMP-THERMO PLASTIC 94V-0	BLACK COLOR
B	EARTH	1	COPPER ALLOY 0.20T	GOLD FLASH
C	TIP	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder fill/all over Nickel Plated
D	SHUNT	1	COPPER ALLOY 0.25T	GOLD FLASH
E	RING	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder fill/all over Nickel Plated
F	MAKE TERMINAL	1	COPPER ALLOY 0.20T	GOLD FLASH
G	TRANSFER TERMINAL	1	COPPER ALLOY 0.20T	△ Gold Flash on contact area and Solder fill/all over Nickel Plated
H	SHIELD	1	COPPER ALLOY 0.20T	NI PLATING
I	MYLAR	1	T=0.075	
J	MYLAR	1	T=0.075	

UNLESS OTHERWISE SPECIFIED TOLERANCES:	DECIMALS:	ANGLES:
X	±0.5	X ±2°
X.X	±0.3	X.X ±1'
X.XX	±0.2	

TITLE	PART NO.	UNIT	SHEET	REV.
3.5Ø PHONE JACK	2SJ2285-002143	mm	10F1	C

APVD: ZLS 14/8/19 SIZE: A3 SHEET: 10F1 REV: C

CUSTOMER COPY

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